

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5063082

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SEONG CHEOL HONG	07/06/2018
JAE KYOUM KIM	07/17/2018
KI YOUNG MIN	07/06/2018
SE MIN PARK	07/06/2018
MYUNG SIK CHUN	07/16/2018
GYOO TAEK LEE	07/06/2018
OH YEOUL KWON	07/06/2018
HYUN CHUL PARK	07/18/2018
RECEIVING PARTY DATA	
Name:	POSCO
Street Address:	(GOEDONG-DONG) 6261, DONGHEAN-RO, NAM-GU
City:	POHANG-SI, GYEONGSANGBUK-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	37859
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16072143
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-756-8000
Email:	ipdocketmwe@mwe.com, smjohnson@mwe.com
Correspondent Name:	MCDERMOTT WILL & EMERY LLP
Address Line 1:	THE MCDERMOTT BUILDING
Address Line 2:	500 NORTH CAPITOL STREET, N.W.
Address Line 4:	WASHINGTON, D.C. 20001
ATTORNEY DOCKET NUMBER:	097358-0065
NAME OF SUBMITTER:	HOSANG LEE
SIGNATURE:	/Hosang Lee/

PATENT

DATE SIGNED:	07/23/2018
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Total Attachments: 9
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COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

METHOD FOR REFINING MAGNETIC DOMAINS OF GRAIN-ORIENTED ELECTRICAL STEEL PLATES, AND APPARATUS THEREFOR

which application is:

attached, or

United States application number or PCT international application number __
PCT/KR2016/015161 filed on December 23, 2016.

The above-identified application was made or authorized to be made by me.

In the event that the filing date and/or application number are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request the registered practitioners of **McDermott Will & Emery LLP**, associated with the Customer Number **20277**, to insert above the filing date and/or application number of the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

POSCO

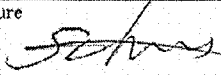
having an address at **(Goedong-dong) 6261, Donghaean-ro, Nam-gu, Pohang-si, Gyeongsangbuk-do 37859, Republic of Korea**

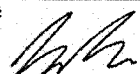
hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

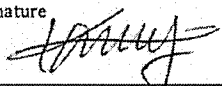
I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;


I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.


Legal name of FIRST inventor HONG, Seong Cheol	
First inventor's signature 	Date 2018.7.6

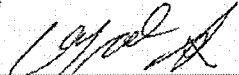
Legal name of SECOND inventor KIM, Jae Kyoum	
Second inventor's signature 	Date 2018.7.17

Legal name of THIRD inventor MIN, Ki Young	
Third inventor's signature 	Date 2018.7.6

Legal name of FOURTH inventor PARK, Se min	
Fourth inventor's signature 	Date 2018.7.6

Legal name of FIFTH inventor CHUN, Myung Sik	
Fifth inventor's signature	Date

Legal name of SIXTH inventor LEE, Gyoo Taek	
Sixth inventor's signature 	Date 2018.7.6

Legal name of SEVENTH inventor KWON, Oh Yeoul	
Seventh inventor's signature 	Date 2018.7.6

Legal name of EIGHTH inventor PARK, Hyun Chul	
Eighth inventor's signature	Date

2018-2476

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For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

POSCO

having an address at **(Goedong-dong) 6261, Donghaean-ro, Nam-gu, Pohang-si, Gyeongsangbuk-do 37859, Republic of Korea**

hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

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Attorney Docket No.

Legal name of FIRST inventor HONG, Seong Cheol	
First inventor's signature	Date

Legal name of SECOND inventor KIM, Jae Kyoum	
Second inventor's signature	Date

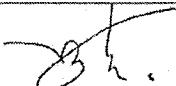
Legal name of THIRD inventor MIN, Ki Young	
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Fourth inventor's signature	Date

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Fifth inventor's signature	Date

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Sixth inventor's signature	Date

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Seventh inventor's signature	Date

Legal name of EIGHTH inventor PARK, Hyun Chul	
Eighth inventor's signature 	Date 2018. 7. 18

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Legal name of FOURTH inventor PARK, Se min	
Fourth inventor's signature	Date

Legal name of FIFTH inventor CHUN, Myung Sik	
Fifth inventor's signature <i>Chun</i>	Date <i>July 16, 2018</i>

Legal name of SIXTH inventor LEE, Gyo Taek	
Sixth inventor's signature	Date

Legal name of SEVENTH inventor KWON, Oh Yeoul	
Seventh inventor's signature	Date

Legal name of EIGHTH inventor PARK, Hyun Chul	
Eighth inventor's signature	Date

2018-2498
PATENT